

Thyristors logic level for RCD/GFI/LCCB applications

Rev. 04 — 20 August 2004

**Product data sheet** 

## 1. Product profile

### 1.1 General description

Passivated, sensitive gate thyristors in a SOT54 plastic package.

### 1.2 Features

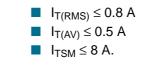
Designed to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

### **1.3 Applications**

For use in Residual Current Devices (RCD), Ground Fault Interrupters (GFI) and Leakage Current Circuit Breakers (LCCB) applications, where a minimum I<sub>GT</sub> limit is needed.

### 1.4 Quick reference data

- $V_{DRM}, V_{RRM} \le 500 \text{ V} (BT168E)$



### 2. Pinning information

Table 1:	Discrete pinning	
Pin	Description	Simplified outline Symbol
1	anode (a)	
2	gate (g)	
3	cathode (k)	Sym037
		SOT54 (TO-92)



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## 3. Ordering information

Table 2: Ordering information						
Type number	Package					
	Name	Description	Version			
BT168E	-	plastic single-ended leaded (through hole) package; 3 leads	SOT54			
BT168G						

## 4. Limiting values

#### Table 3: Limiting values

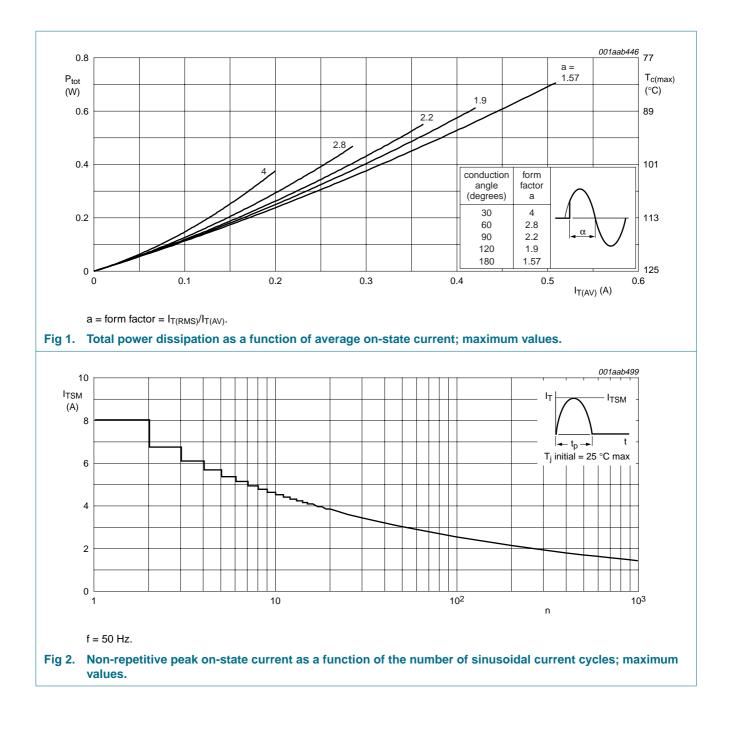
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit		
V <sub>DRM</sub> , V <sub>RRM</sub>	repetitive peak off-state voltage						
	BT168E		<u>[1]</u> _	500	V		
	BT168G		<u>[1]</u> _	600	V		
I <sub>T(AV)</sub>	average on-state current	half sine wave; T <sub>lead</sub> ≤ 83 °C; see <u>Figure 1</u>	-	0.5	A		
I <sub>T(RMS)</sub>	RMS on-state current	all conduction angles; see <mark>Figure 4</mark> and <u>5</u>	-	0.8	А		
I <sub>TSM</sub>	non-repetitive peak on-state current	half sine wave; T <sub>j</sub> = 25 °C prior to surge; see <u>Figure 2</u> and <u>3</u>					
		t = 10 ms	-	8	А		
		t = 8.3 ms	-	9	А		
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t = 10 ms	-	0.32	A <sup>2</sup> s		
dl <sub>T</sub> /dt	repetitive rate of rise of on-state current after triggering	$I_{TM}$ = 2 A; $I_G$ = 10 mA; dI <sub>G</sub> /dt = 100 mA/µs	-	50	A/μs		
I <sub>GM</sub>	peak gate current		-	1	А		
V <sub>GM</sub>	peak gate voltage		-	5	V		
V <sub>RGM</sub>	peak reverse gate voltage		-	5	V		
P <sub>GM</sub>	peak gate power		-	2	W		
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.1	W		
T <sub>stg</sub>	storage temperature		-40	+150	°C		
Tj	junction temperature		-	125	°C		

[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15  $A/\mu s$ .

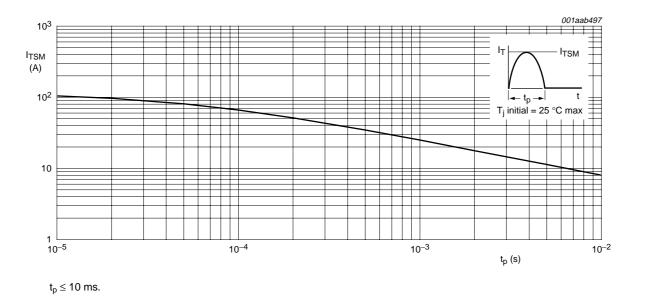
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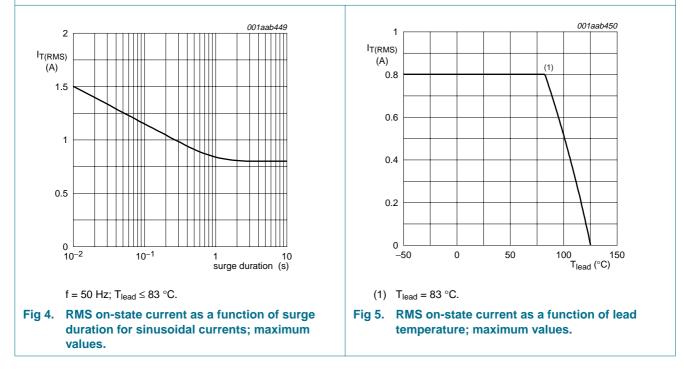


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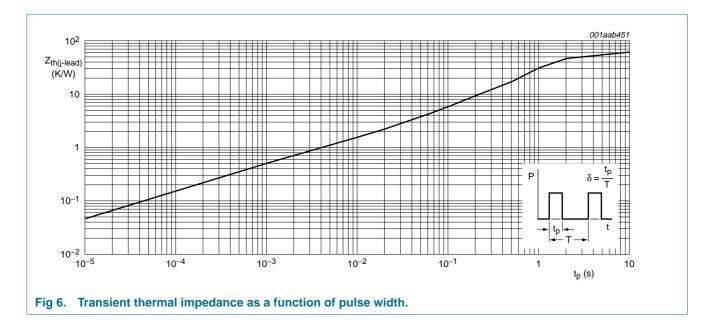




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## 5. Thermal characteristics

Table 4:	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead		-	-	60	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	printed-circuit board mounted; lead length = 4 mm	-	150	-	K/W



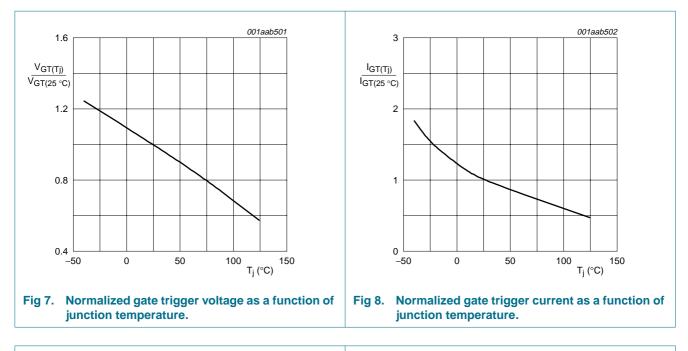
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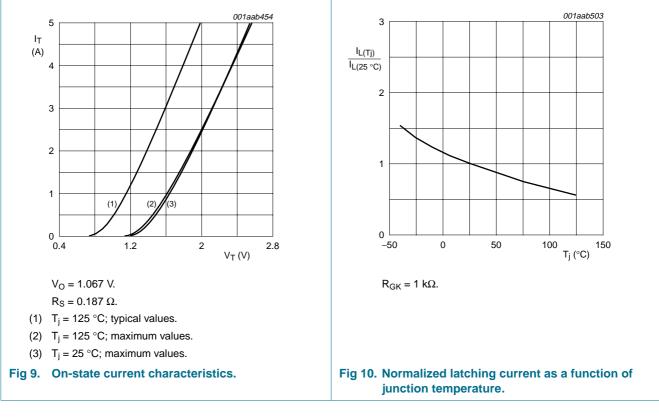
## 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static cha	racteristics					
I <sub>GT</sub>	gate trigger current	V <sub>D</sub> = 12 V; I <sub>T</sub> = 10 mA; gate open circuit; see <mark>Figure 8</mark>	20	50	200	μA
IL	latching current	$V_D$ = 12 V; I <sub>GT</sub> = 0.5 mA; R <sub>GK</sub> = 1 kΩ; see <u>Figure 10</u>	-	2	6	mA
I <sub>H</sub>	holding current	$V_D$ = 12 V; I <sub>GT</sub> = 0.5 mA; R <sub>GK</sub> = 1 kΩ; see <u>Figure 11</u>	-	2	5	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.2 A	-	1.25	1.7	V
V <sub>GT</sub>	gate trigger voltage	I <sub>T</sub> = 10 mA; gate open circuit; see <u>Figure 7</u>				
		V <sub>D</sub> = 12 V	-	0.5	0.8	V
		$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	0.2	0.3	-	V
I <sub>D</sub> , I <sub>R</sub>	off-state leakage current	$      V_D = V_{DRM(max)}; V_R = V_{RRM(max)};            T_j = 125 °C; R_{GK} = 1 k\Omega $	-	0.05	0.1	mA
Dynamic o	haracteristics					
dV <sub>D</sub> /dt	critical rate of rise of off-state voltage	$V_{DM} = 67 \% V_{DRM(max)}; T_j = 125 °C;$ exponential waveform; see Figure 12				
		$R_{GK}$ = 1 k $\Omega$	500	800	-	V/μs
		gate open circuit	-	25	-	V/µs
t <sub>gt</sub>	gate controlled turn-on time	$\begin{split} I_{TM} &= 2 \text{ A};  V_D = V_{DRM(max)}; \\ I_G &= 10 \text{ mA};  dI_G/dt = 0.1  A/\mu s \end{split}$	-	2	-	μs
tq	circuit commuted turn-off time		-	100	-	μs

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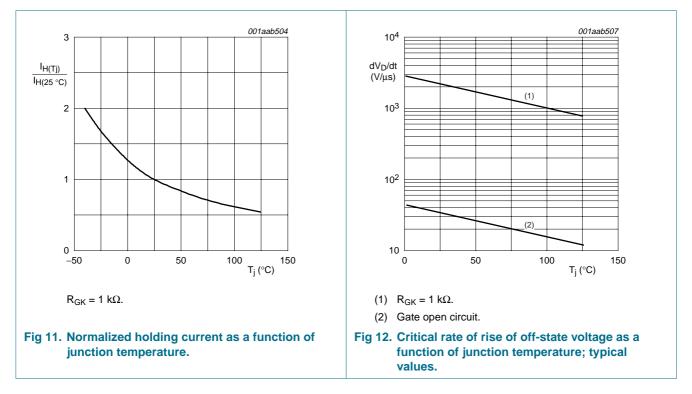




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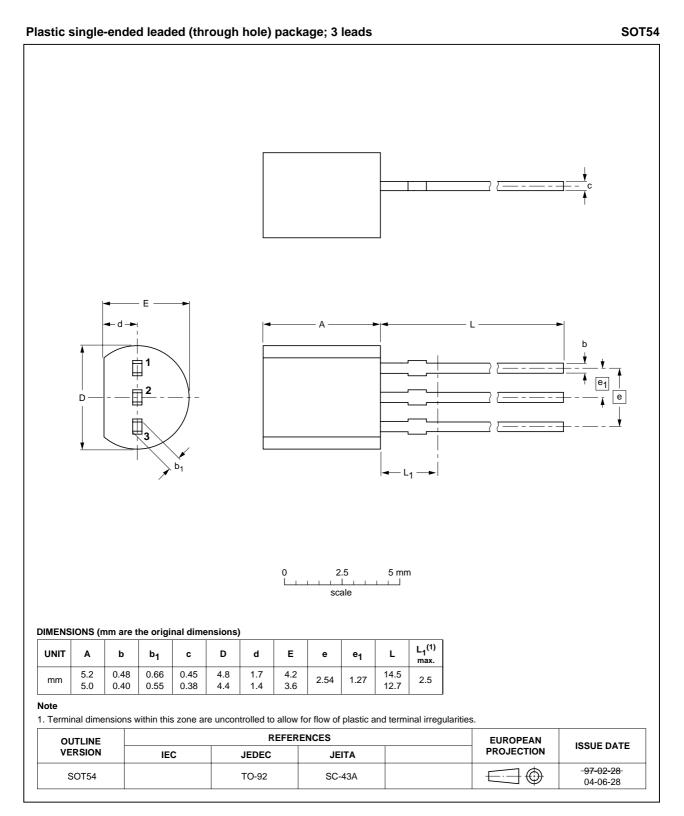
## 7. Package information

Epoxy meets requirements of UL94 V-0 at  $\frac{1}{8}$  inch.

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### 8. Package outline



#### Fig 13. Package outline.

9397 750 13511 Product data sheet

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## 9. Revision history

Table 6:	Revision histor	у
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Document ID	Release date	Data sheet status	Change notice	Order number	Supersedes
BT168_SERIES_4	20040820	Product data sheet	-	9397 750 13511	BT168_SERIES_3
Modifications:		t of this data sheet has be n standard of Philips Sem		comply with the new	v presentation and
BT168_SERIES_3	20010902	Product specification	-	not applicable	BT168_SERIES_2
BT168_SERIES_2	20010901	Product specification	-	not applicable	BT168_SERIES_1
BT168_SERIES_1	19970901	Product specification	-	not applicable	-

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### 10. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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